# CMOS 16-bit Single Chip Microcomputer

Description

The CXP913040 is a CMOS 16-bit microcomputer integrating on a single chip an A/D converter, serial interface with an incorporated buffer RAM, high-precision timing pattern generation function, pulse cycle measurement circuit, PWM generator, general-purpose prescaler, vertical sync separation circuit, and a measurement circuit which measures the signals of capstan FG, drum FG/PG, reel FG and other servo systems with high precision, as well as basic configurations like a 16-bit CPU, ROM, RAM, and I/O port.

This LSI also provides sleep/stop modes that enable lower power consumption.
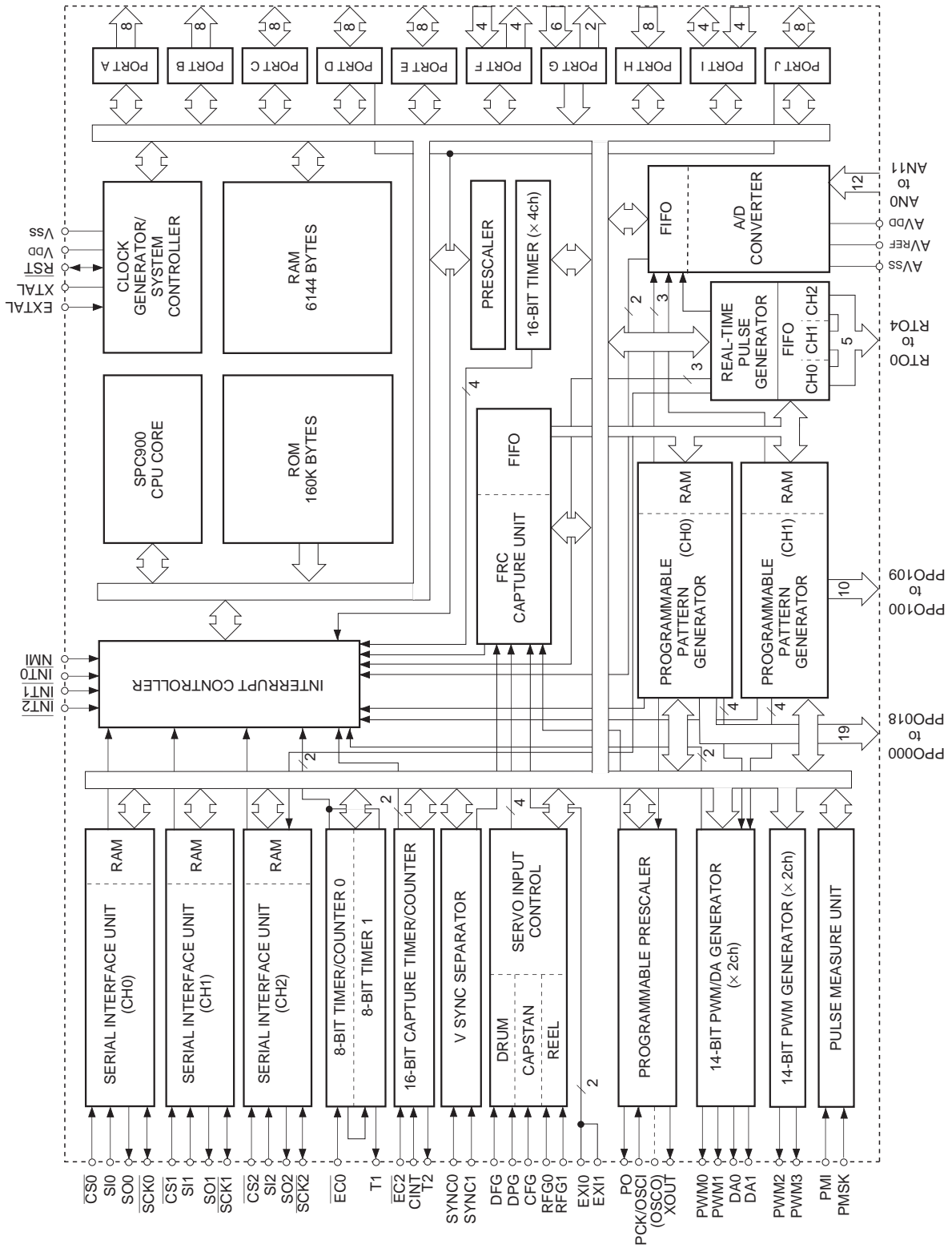
100 pin LQFP (Plastic)
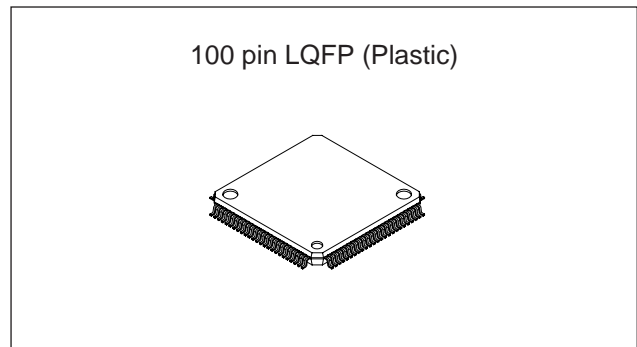
Structure

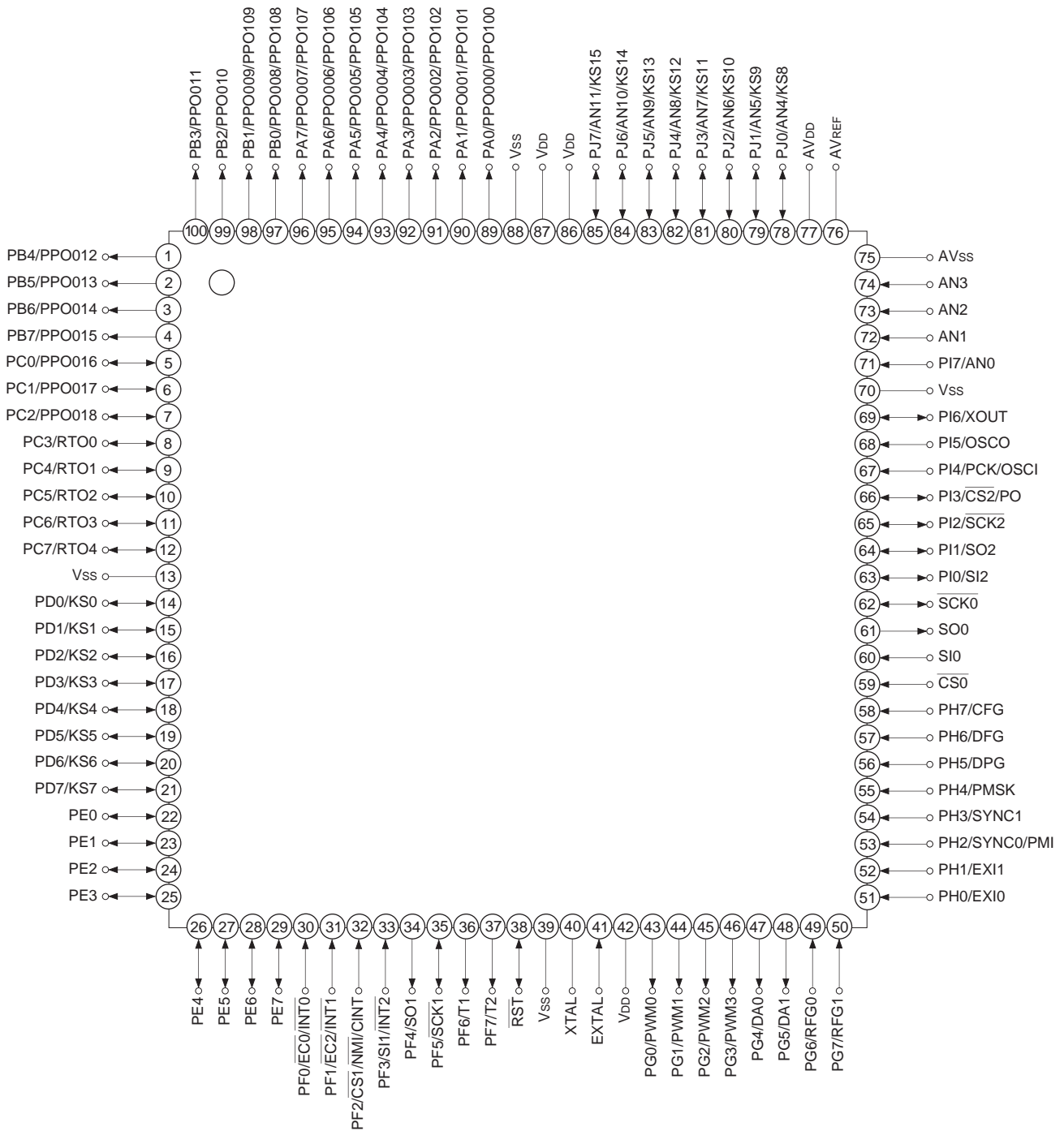Silicon gate CMOS IC

Features

- An efficient instruction set as a controller
  — Direct addressing, numerous abbreviated forms, multiplication and division instructions
- Instruction sets for C language and RTOS
  — Highly quadratic instruction system, general-purpose register of 16-bit × 8-pin × 16-bank configuration
- Minimum instruction cycle time   100ns at 20MHz operation
- Incorporated ROM capacity   160K bytes
- Incorporated RAM capacity   6144 bytes
- Peripheral functions
  — A/D converter   8-bit 12-channel successive approximation system, automatic scanning function, 8-stage (soft) + 4-stage (hard) FIFO for conversion results (Conversion time: 20µs at 20MHz)
  — Serial interface   Buffer RAM (128 bytes, supports high-speed transfer mode), 3 channels
  — Timers   8-bit timer/counter + 8-bit timer (with timing output), 1 channel
  16-bit capture timer/counter (with timing output), 1 channel
  16-bit timer, 4 channels
  — High-precision timing pattern generator   PPG for 27 pins, 42 stages (max.)
  PPG for 16 pins, 16 stages (max.)
  RTG for 5 pins, 3 channels
  — PWM/DA gate output   PWM for 14 bits, 2 channels
  (Repetitive frequency of 39.1kHz, 20MHz)
  DA gate pulse for 14 bits, 2 channels
  — Servo input control   Capstan FG, drum FG/PG, reel FG
  — VSYNC separator
  — FRC capture unit   24-bit and 8-stage FIFO
  — PWM output   14 bits, 2 channels
  — General-purpose prescaler   10 bits, 1 channel
  — Pulse cycle measurement circuit   1 channel with mask input
- General-purpose I/O   80 pins
  (max.; when all multi-purpose pins are used as general-purpose I/O.)
- Interruption   28 factors, 28 vectors, multi-interruption and priority selection possible
- Standby mode   Sleep/stop
- Package   100-pin plastic LQFP
- Piggy/evaluation chip   CXP913000 100-pin ceramic LQFP

E96X05-PS

Block Diagram

Pin Configuration (Top View)

Top pins (100-76, left to right):
- 100: PB3/PPO011
- 99: PB2/PPO010
- 98: PB1/PPO009/PPO109
- 97: PB0/PPO008/PPO108
- 96: PA7/PPO007/PPO107
- 95: PA6/PPO006/PPO106
- 94: PA5/PPO005/PPO105
- 93: PA4/PPO004/PPO104
- 92: PA3/PPO003/PPO103
- 91: PA2/PPO002/PPO102
- 90: PA1/PPO001/PPO101
- 89: PA0/PPO000/PPO100
- 88: Vss
- 87: VDD
- 86: VDD
- 85: PJ7/AN11/KS15
- 84: PJ6/AN10/KS14
- 83: PJ5/AN9/KS13
- 82: PJ4/AN8/KS12
- 81: PJ3/AN7/KS11
- 80: PJ2/AN6/KS10
- 79: PJ1/AN5/KS9
- 78: PJ0/AN4/KS8
- 77: AVDD
- 76: AVREF

Left pins (1-25):
- 1: PB4/PPO012
- 2: PB5/PPO013
- 3: PB6/PPO014
- 4: PB7/PPO015
- 5: PC0/PPO016
- 6: PC1/PPO017
- 7: PC2/PPO018
- 8: PC3/RTO0
- 9: PC4/RTO1
- 10: PC5/RTO2
- 11: PC6/RTO3
- 12: PC7/RTO4
- 13: Vss
- 14: PD0/KS0
- 15: PD1/KS1
- 16: PD2/KS2
- 17: PD3/KS3
- 18: PD4/KS4
- 19: PD5/KS5
- 20: PD6/KS6
- 21: PD7/KS7
- 22: PE0
- 23: PE1
- 24: PE2
- 25: PE3

Right pins (75-51):
- 75: AVss
- 74: AN3
- 73: AN2
- 72: AN1
- 71: PI7/AN0
- 70: Vss
- 69: PI6/XOUT
- 68: PI5/OSCO
- 67: PI4/PCK/OSCI
- 66: PI3/CS2/PO
- 65: PI2/SCK2
- 64: PI1/SO2
- 63: PI0/SI2
- 62: SCK0
- 61: SO0
- 60: SI0
- 59: CS0
- 58: PH7/CFG
- 57: PH6/DFG
- 56: PH5/DPG
- 55: PH4/PMSK
- 54: PH3/SYNC1
- 53: PH2/SYNC0/PMI
- 52: PH1/EXI1
- 51: PH0/EXI0

Bottom pins (26-50, left to right):
- 26: PE4
- 27: PE5
- 28: PE6
- 29: PE7
- 30: PF0/EC0/INT0
- 31: PF1/EC2/INT1
- 32: PF2/CS1/NMI/CINT
- 33: PF3/SI1/INT2
- 34: PF4/SO1
- 35: PF5/SCK1
- 36: PF6/T1
- 37: PF7/T2
- 38: RST
- 39: Vss
- 40: XTAL
- 41: EXTAL
- 42: VDD
- 43: PG0/PWM0
- 44: PG1/PWM1
- 45: PG2/PWM2
- 46: PG3/PWM3
- 47: PG4/DA0
- 48: PG5/DA1
- 49: PG6/RFG0
- 50: PG7/RFG1

Note) 1. Vss (Pins 13, 39, 70 and 88) must be connected to GND.

2. VDD (Pins 42, 86 and 87) must be connected to VDD.

Pin Description

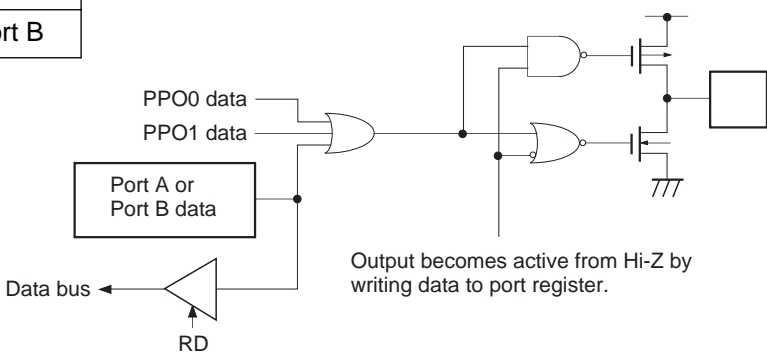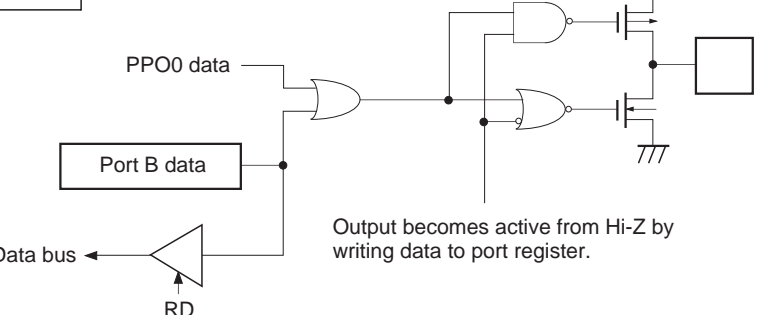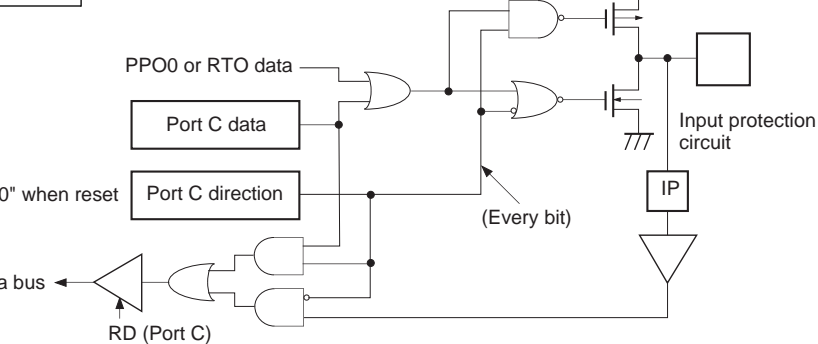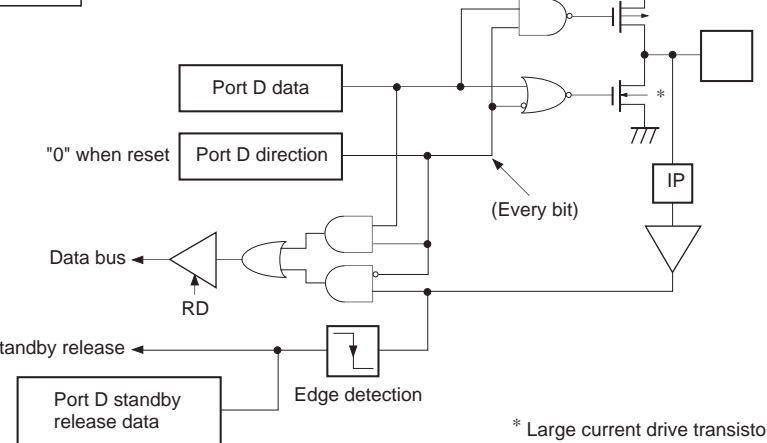| Symbol	I/O	Functions		
PA0/PPO000 /PPO100 to PA7/PPO007 /PPO107	Output / Real time output / Real time output	(Port A) 8-bit output port. Data is gated with PPO0 and PPO1 contents by OR-gate and they are output. (8 pins)	Programmable pattern generator (PPG0, PPG1) output. Functions as high-precision real-time pulse output port. (PPG0 19 pins, PPG1 10 pins)	
PB0/PPO008 /PPO108 PB1/PPO009 /PPO109	Output / Real time output / Real time output	(Port B) 8-bit output port. Data is gated with PPO0 and PPO1 contents by OR-gate and they are output. (8 pins)		
PB2/PPO010 to PB7/PPO015	Output / Real time output			
PC0/PPO016 to PC2/PPO018	Output / Real time output	(Port C) 8-bit I/O port. I/O can be specified by bit unit.		
PC3/RTO0 to PC7/RTO4	Output / Real time output	Data is gated with PPO0 or RTO contents by OR-gate and they are output. (8 pins)	Real-time pulse generator (RTG) output. Functions as high-precision real-time pulse output port. (5 pins)	
PD0 to PD7	I/O	(Port D) 8-bit I/O port. I/O can be specified by bit unit. Standby release input function can also be specified by bit unit. Can drive 12mA sink current when V_{DD} = 5V. (8 pins)		
PE0 to PE7	I/O	(Port E) 8-bit I/O port. I/O can be specified by bit unit. Can drive 12mA sink current when V_{DD} = 5V. (8 pins)		
PF0/$\overline{EC0}$/ $\overline{INT0}$	Input / Input / Input	(Port F) 8-bit port. Lower 4 bits are for input; upper 4 bits are for output. (8 pins)	External event input for timer/counter. (2 pins)	Input to request external interruption. Active at the falling edge. (2 pins)
PF1/$\overline{EC2}$/ $\overline{INT1}$	Input / Input / Input			
PF2/$\overline{CS1}$/ $\overline{NMI}$/CINT	Input / Input / Input / Input		Serial chip select (CH1) input. / Input to request non-maskable interruption. Active at the falling edge.	External capture input for 16-bit timer/counter.
PF3/SI1/$\overline{INT2}$	Input / Input / Input		Serial data (CH1) input.	Input to request external interruption. Active at the falling edge.
PF4/SO1	Output / Output		Serial data (CH1) output.	
PF5/$\overline{SCK1}$	Output / I/O		Serial data (CH1) I/O.	
PF6/T1	Output / Output		8-bit timer/counter output.	
PF7/T2	Output / Output		16-bit capture timer/counter output.	

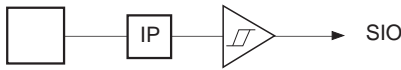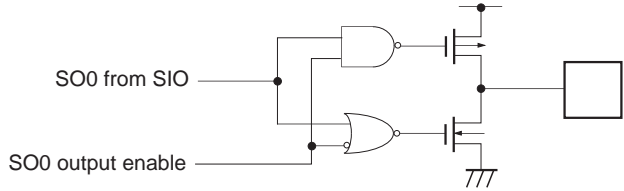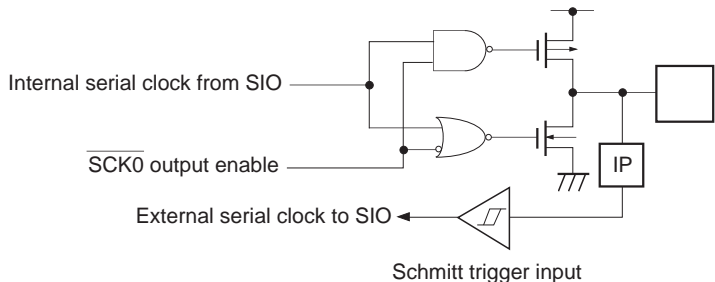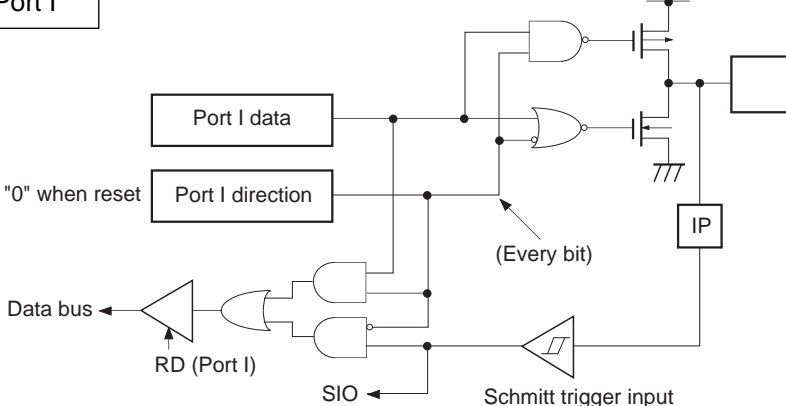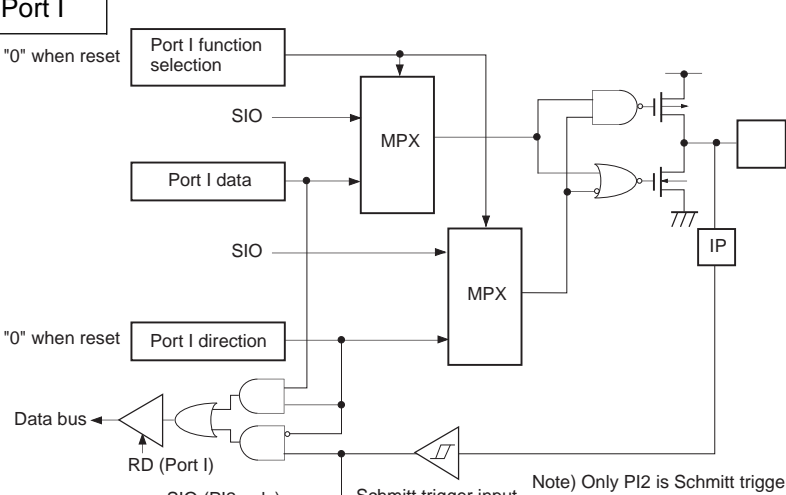| Symbol	I/O	Functions		
PG0/PWM0	Output / Output	(Port G) 8-bit port. Lower 6 bits are for output; upper 2 bits are for input. (8 pins)	14-bit PWM output. (4 pins)	
PG1/PWM1	Output / Output			
PG2/PWM2	Output / Output			
PG3/PWM3	Output / Output			
PG4/DA0	Output / Output		DA gate pulse output. (2 pins)	
PG5/DA1	Output / Output			
PG6/RFG0	Input / Input		Reel FG input. (2 pins)	
PG7/RFG1	Input / Input			
PH0/EXI0	Input / Input	(Port H) 8-bit input port. (8 pins)	External input for FRC capture unit. (2 pins)	
PH1/EXI1	Input / Input			
PH2/ SYNC0/PMI	Input / Input / Input		Composite sync signal input. (2 pins)	Pulse input for pulse cycle measurement circuit.
PH3/SYNC1	Input / Input			
PH4/PMSK	Input / Input		Mask input for pulse cycle measurement circuit.	
PH5/DPG	Input / Input		Drum PG input.	
PH6/DFG	Input / Input		Drum FG input.	
PH7/CFG	Input / Input		Capstan FG input.	
$\overline{SCK0}$	I/O	Serial clock (CH0) I/O.		
SO0	Output	Serial data (CH0) output.		
SI0	Input	Serial data (CH0) input.		
$\overline{CS0}$	Input	Serial chip select (CH0) input.		
PI0/SI2	I/O / Input	(Port I) 8-bit port. Lower 4 bits are for I/O; upper 4 bits are for input. Lower 4 bits can be specified by bit unit. (8 pins)	Serial data (CH2) input.	
PI1/SO2	I/O / Output		Serial data (CH2) output.	
PI2/$\overline{SCK2}$	I/O / I/O		Serial clock (CH2) I/O.	
PI3/$\overline{CS2}$/PO	I/O / Input / Output		Serial chip select (CH2) input.	General-purpose prescaler output.
PI4/PCK/ OSCI	Input / Input / Input		General-purpose prescaler external clock input.	Connects a crystal for general-purpose prescaler clock oscillation. (Mask option)
PI5/OSCO	Input / Output			
PI6/XOUT	Input / Output		Clock output from clock generator or general-purpose prescaler.	
PI7/AN0	Input / Input			
AN1 to AN3	Input			
PJ0/AN4 to PJ7/AN11	I/O / Input	(Port J) 8-bit I/O port. I/O can be specified by bit unit. Standby release input function can also be specified by bit unit. (8 pins)	Analog input for A/D converter. (12 pins)	

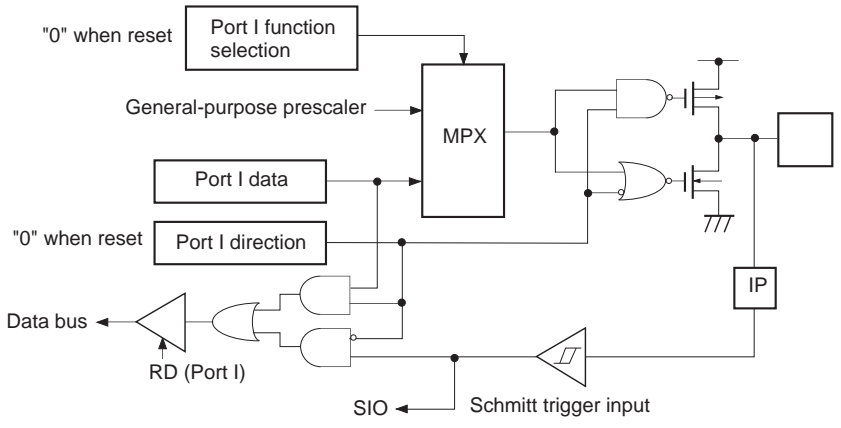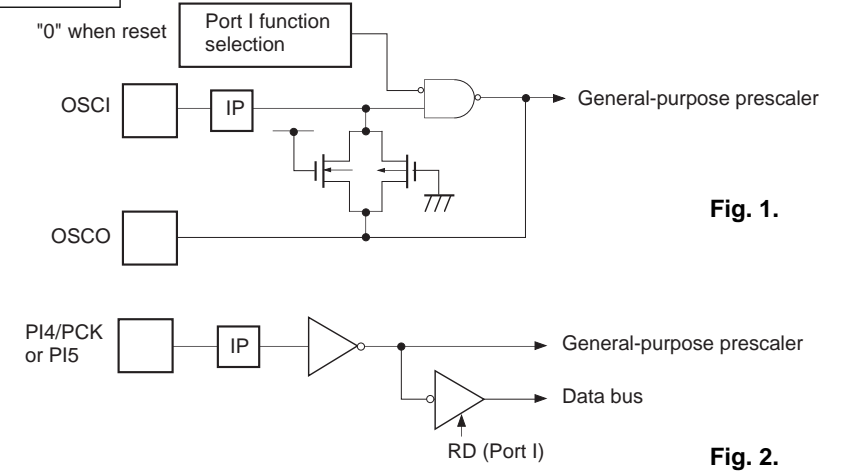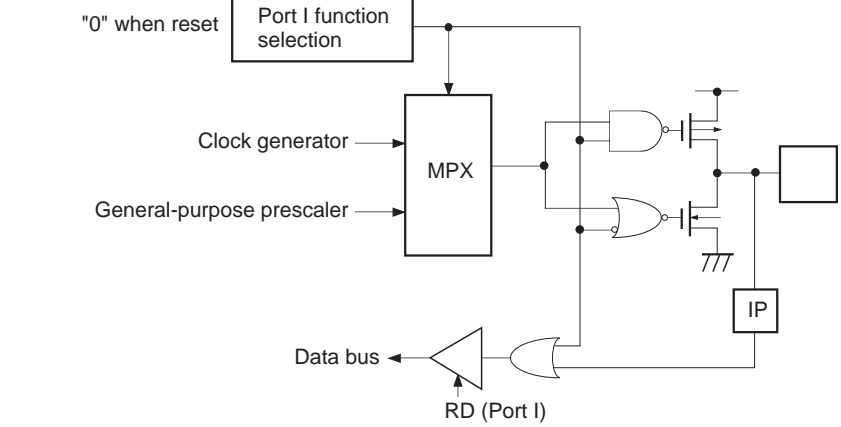| Symbol	I/O	Functions
EXTAL	Input	Connects a crystal for system clock oscillation. When the clock is supplied externally, input it to EXTAL and input an opposite phase clock to XTAL.
XTAL	Output	
$\overline{\text{RST}}$	I/O	System reset. Active at "L" level.
AV_{DD}		Positive power supply for A/D converter.
AV_{REF}	Input	Reference voltage input for A/D converter.
AV_{SS}		A/D converter GND.
V_{DD}		Positive power supply. All three V_{DD} pins must be connected to the positive power supply.
V_{SS}		GND. All four V_{SS} pins must be connected to GND.

I/O Circuit Format for Pins
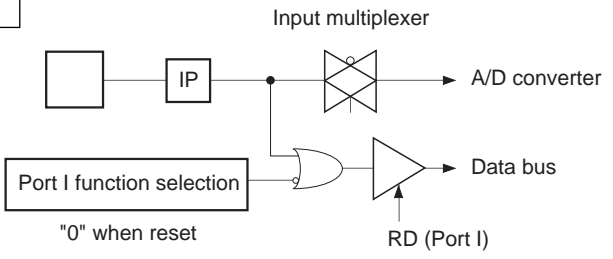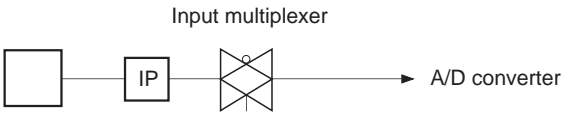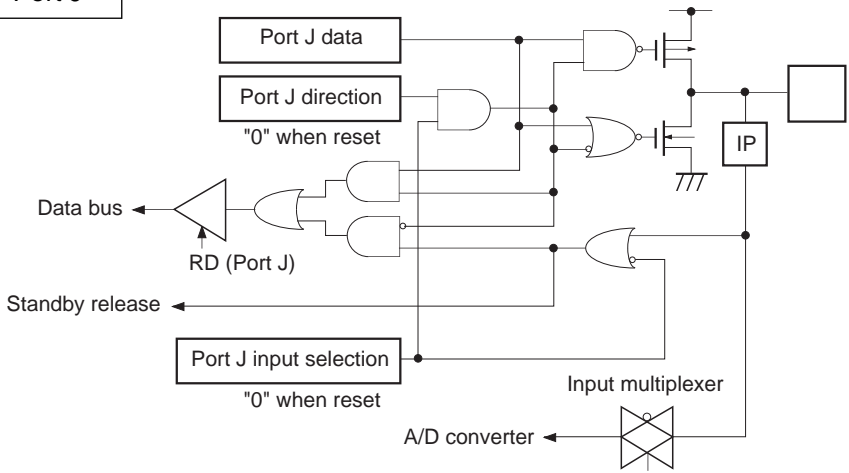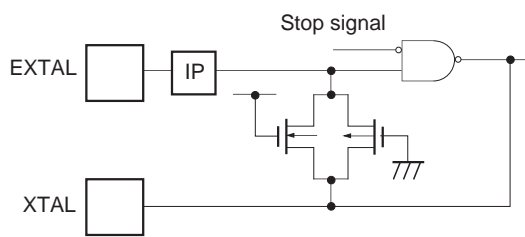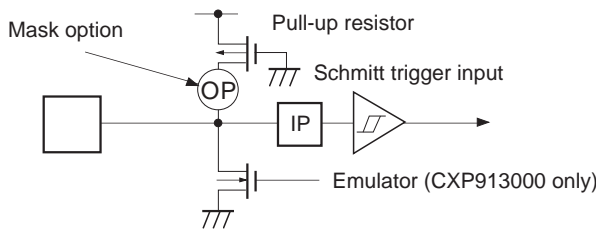
Pin	Circuit format	When reset
PA0/PPO000/ PPO100 to PA7/PPO007/ PPO107 PB0/PPO008/ PPO108 to PB1/PPO009/ PPO109 10 pins	Port A / Port B PPO0 data PPO1 data Port A or Port B data Data bus ← RD Output becomes active from Hi-Z by writing data to port register.	Hi-Z
PB2/PPO010 to PB7/PPO015 6 pins	Port B PPO0 data Port B data Data bus ← RD Output becomes active from Hi-Z by writing data to port register.	Hi-Z
PC0/PPO016 to PC2/PPO018 PC3/RTO0 to PC7/RTO4 8 pins	Port C PPO0 or RTO data Port C data "0" when reset Port C direction (Every bit) Input protection circuit IP Data bus ← RD (Port C)	Hi-Z
PD0/KS0 to PD7/KS7 8 pins	Port D Port D data "0" when reset Port D direction (Every bit) * IP Data bus ← RD Standby release ← Edge detection Port D standby release data * Large current drive transistor	Hi-Z

Pin	Circuit format	When reset
PE0 to PE7 8 pins	**Port E** Port E data "0" when reset — Port E direction (Every bit) IP Data bus ← RD * Large current drive transistor	Hi-Z
PF0/$\overline{EC0}$/$\overline{INT0}$ PF1/$\overline{EC2}$/$\overline{INT1}$ PF3/SI1/$\overline{INT2}$ 3 pins	**Port F** Schmitt trigger input IP Interrupt circuit and timer/counter or SIO Data bus RD (Port F)	Hi-Z
$\overline{PF2}$/$\overline{CS1}$/ $\overline{NMI}$/CINT 1 pin	**Port F** "0" when reset Port F function selection Schmitt trigger input Interrupt circuit Timer/counter or SIO IP Data bus RD (Port F)	Hi-Z
PF4/SO1 1 pin	**Port F** "0" when reset — Port F function selection SO1 from SIO → MPX Port F data Data bus ← RD (Port F) Hi-Z control	Hi-Z

Pin	Circuit format	When reset
PF5/$\overline{\text{SCK1}}$ 1 pin	**Port F** "0" when reset — Port F function selection Internal serial clock from SIO → MPX Port F data Data bus ← RD (Port F) Hi-Z control IP SIO ← Schmitt trigger input	Hi-Z
PF6/T1 PF7/T2 2 pins	**Port F** "0" when reset — Port F function selection Timer/counter → MPX "1" when reset — Port F data Data bus ← RD (Port F)	"H" level
PG0/PWM0 PG1/PWM1 PG2/PWM2 PG3/PWM3 PG4/DA0 PG5/DA1 6 pins	**Port G** "0" when reset — Port G function selection DA gate output or PWM output → MPX Port G data Data bus ← RD (Port G) Hi-Z control	Hi-Z
PG6/RFG0 PG7/RFG1 2 pins	**Port G** Schmitt trigger input IP → Servo circuit → Data bus RD (Port G)	Hi-Z
PH0/EXI0 PH1/EXI1 PH2/SYNC0/PMI PH3/SYNC1 PH4/PMSK PH5/DPG PH6/DFG PH7/CFG 8 pins	**Port H** Schmitt trigger input IP → Servo circuit → Data bus RD (Port H) Note) PH2/SYNC0/PMI and PH3/SYNC1 can select CMOS Schmitt trigger input or TTL Schmitt trigger input with the mask option.	Hi-Z

Pin	Circuit format	When reset
$\overline{\text{CS0}}$ SI0 2 pins	Schmitt trigger input IP → SIO	Hi-Z
SO0 1 pin	SO0 from SIO SO0 output enable	Hi-Z
$\overline{\text{SCK0}}$ 1 pin	Internal serial clock from SIO $\overline{\text{SCK0}}$ output enable External serial clock to SIO IP Schmitt trigger input	Hi-Z
PI0/SI2 1 pin	Port I Port I data "0" when reset Port I direction (Every bit) IP Data bus ← RD (Port I) SIO Schmitt trigger input	Hi-Z
PI1/SO2 PI2/$\overline{\text{SCK2}}$ 2 pins	Port I "0" when reset Port I function selection SIO → MPX Port I data SIO → MPX "0" when reset Port I direction IP Data bus ← RD (Port I) SIO (PI2 only) ← Schmitt trigger input Note) Only PI2 is Schmitt trigger input.	Hi-Z

Pin	Circuit format	When reset
PI3/$\overline{CS2}$/PO 1 pin	**Port I** "0" when reset → Port I function selection General-purpose prescaler → MPX Port I data "0" when reset → Port I direction Data bus ← RD (Port I) IP SIO ← Schmitt trigger input	Hi-Z
PI4/PCK/OSCI PI5/OSCO 2 pins	**Port I** "0" when reset → Port I function selection OSCI → IP → General-purpose prescaler OSCO **Fig. 1.** PI4/PCK or PI5 → IP → General-purpose prescaler Data bus RD (Port I) **Fig. 2.** Note) The circuit format in Fig. 1 or Fig. 2 can be selected with the mask option.	Oscillation Hi-Z
PI6/XOUT 1 pin	**Port I** "0" when reset → Port I function selection Clock generator → MPX General-purpose prescaler → MPX IP Data bus ← RD (Port I)	Hi-Z

Pin	Circuit format	When reset
PI7/AN0 1 pin	**Port I** Input multiplexer IP → A/D converter Port I function selection "0" when reset RD (Port I) → Data bus	Hi-Z
AN1 to AN3 3 pins	Input multiplexer IP → A/D converter	Hi-Z
PJ0/AN4/KS8 to PJ7/AN11/KS15 8 pins	**Port J** Port J data Port J direction "0" when reset IP Data bus ← RD (Port J) Standby release ← Port J input selection "0" when reset Input multiplexer A/D converter ←	Hi-Z
EXTAL XTAL 2 pins	Stop signal EXTAL — IP XTAL • Diagram shows circuit composition during oscillation. • Feedback resistor is removed during stop mode.	Oscillation
$\overline{RST}$ 1 pin	Mask option Pull-up resistor OP Schmitt trigger input IP Emulator (CXP913000 only)	"L" level

Absolute Maximum Ratings   (Vss = 0V reference)

Item	Symbol	Rating	Unit	Remarks
Supply voltage	V_{DD}	−0.3 to +7.0	V	
	AV_{DD}	AVss to +7.0[*1]	V	
	AV_{SS}	−0.3 to +0.3	V	
Input voltage	V_{IN}	−0.3 to +7.0[*2]	V	
Output voltage	V_{OUT}	−0.3 to +7.0[*2]	V	
High level output current	I_{OH}	−5	mA	
High level total output current	$\sum I_{OH}$	−50	mA	Total for all output pins
Low level output current	I_{OL}	15	mA	All pins excluding large current output pins
	I_{OLC}	20	mA	Large current output pins[*3]
Low level total output current	$\sum I_{OL}$	130	mA	Total for all output pins
Operating temperature	Topr	−20 to +75	°C	
Storage temperature	Tstg	−55 to +150	°C	
Allowable power dissipation	P_D	380	mW	

[*1] AV_{DD} and V_{DD} must be the same voltage.

[*2] V_{IN} and V_{OUT} must not exceed V_{DD} + 0.3V.

[*3] N-ch transistors of PD and PE output ports are the large current drive transistors.

Note)   Usage exceeding absolute maximum ratings may permanently impair the LSI. Normal operation should be conducted under the recommended operating conditions. Exceeding these conditions may adversely affect the reliability of the LSI.

Recommended Operating Conditions

(Vss = 0V reference)

Item	Symbol	Min.	Max.	Unit	Remarks
Supply voltage	V_{DD}	2.7	5.5	V	Guaranteed operation range for high-speed mode (1/2 frequency dividing clock)
		2.7	5.5	V	Guaranteed operation range for low-speed mode (1/16 frequency dividing clock)
		2.5	5.5	V	Guaranteed data hold range during stop mode
Analog voltage	AV_{DD}	2.7	5.5	V	*1
High level input voltage	V_{IH}	$0.7V_{DD}$	V_{DD}	V	*2
	V_{IHS}	$0.8V_{DD}$	V_{DD}	V	CMOS Schmitt trigger input*3
	V_{IHTS}	2.2	V_{DD}	V	TTL Schmitt trigger input*4, *7
	V_{IHEX}	$V_{DD} - 0.4$	$V_{DD} + 0.3$	V	EXTAL*5
Low level input voltage	V_{IL}	0	$0.3V_{DD}$	V	*2
			$0.2V_{DD}$	V	*2, *6
	V_{ILS}	0	$0.2V_{DD}$	V	CMOS Schmitt trigger input*3
	V_{ILTS}	0	0.8	V	TTL Schmitt trigger input*4, *7
	V_{ILEX}	−0.3	0.4	V	EXTAL
Operating temperature	Topr	−20	+75	°C	

*1 AV_{DD} and V_{DD} must be the same voltage.

*2 PC, PD, PE, PI1, PI3 to PI7, PJ for normal input port

*3 $\overline{CS0}$, $\overline{SI0}$, $\overline{SCK0}$, $\overline{RST}$, PF0/$\overline{EC0}$/$\overline{INT0}$, PF1/$\overline{EC2}$/$\overline{INT1}$, PF2/$\overline{CS1}$/$\overline{NMI}$/CINT, PF3/SI1/$\overline{INT2}$, PF5/$\overline{SCK1}$, PG6/RFG0, PG7/RFG1, PH (PH2 and PH3 when CMOS Schmitt trigger input is selected with the mask option), PI0/SI2, PI2/$\overline{SCK2}$.

*4 PH2 and PH3 (when TTL Schmitt trigger input is selected with the mask option).

*5 Specified only during external clock input.

*6 When the supply voltage (V_{DD}) is within the range of 2.7 to 3.6V.

*7 When the supply voltage (V_{DD}) is within the range of 4.5 to 5.5V.

DC Characteristics

(Ta = −20 to +75°C, V_{SS} = 0V reference)

Item	Symbol	Pin	Conditions	Min.	Typ.	Max.	Unit
High level output voltage	V_{OH}	PA to PE, PF6 to PF7, PG0 to PG5, PI0, PI3, PI6, PJ	V_{DD} = 4.5V, I_{OH} = −0.5mA	4.0			V
			V_{DD} = 4.5V, I_{OH} = −1.2mA	3.5			V
			V_{DD} = 2.7V, I_{OH} = −0.15mA	2.4			V
			V_{DD} = 2.7V, I_{OH} = −0.5mA	2.0			V
		PF4, PF5, PI1, PI2, $\overline{SO0}$, $\overline{SCK0}$	V_{DD} = 4.5V, I_{OH} = −4.0mA	3.6			V
			V_{DD} = 3.0V, I_{OH} = −4.0mA	2.0			V
Low level output voltage	V_{OL}	PA to PC, PF4 to PF7, PG0 to PG5, PI0 to PI3, PI6, PJ, $\overline{SO0}$, $\overline{SCK0}$, $\overline{RST}$*1	V_{DD} = 4.5V, I_{OL} = 1.8mA			0.4	V
			V_{DD} = 4.5V, I_{OL} = 3.6mA			0.6	V
			V_{DD} = 2.7V, I_{OL} = 1.2mA			0.3	V
			V_{DD} = 2.7V, I_{OL} = 1.6mA			0.5	V
		PD, PE	V_{DD} = 4.5V, I_{OL} = 12.0mA			1.5	V
			V_{DD} = 2.7V, I_{OL} = 5.0mA			1.0	V
Input current	I_{IHE}	EXTAL	V_{DD} = 5.5V, V_{IH} = 5.5V	0.5		40	µA
			V_{DD} = 3.6V, V_{IH} = 3.6V	0.3		20	µA
	I_{ILE}		V_{DD} = 5.5V, V_{IL} = 0.4V	−0.5		−40	µA
			V_{DD} = 3.6V, V_{IL} = 0.3V	−0.3		−20	µA
	I_{ILR}	$\overline{RST}$*2	V_{DD} = 5.5V, V_{IL} = 0.4V	−1.5		−400	µA
			V_{DD} = 3.6V, V_{IL} = 0.3V	−0.9		−200	µA
I/O leakage current	I_{IZ}	PA to PJ, AN1 to AN3, $\overline{CS0}$, SI0, SO0, SCK0, $\overline{RST}$*2	V_{DD} = 5.5V, V_I = 0, 5.5V			±10	µA
			V_{DD} = 3.6V, V_I = 0, 3.6V			±10	µA
Supply current*3	I_{DD}*4	V_{DD}, V_{SS}	20MHz crystal oscillation (C_1 = C_2 = 10pF), V_{DD} = 5V ± 10%		40	65	mA
			20MHz crystal oscillation (C_1 = C_2 = 10pF), V_{DD} = 3.3V ± 0.3V		22	40	mA
	I_{DDS1}*5		20MHz crystal oscillation (C_1 = C_2 = 10pF), V_{DD} = 5V ± 10%, Sleep mode		8	14	mA
			20MHz crystal oscillation (C_1 = C_2 = 10pF), V_{DD} = 3.3V ± 0.3V, Sleep mode		4.5	8	mA
	I_{DDS2}		V_{DD} = 5.5V, Stop mode			10	µA
			V_{DD} = 3.6V, Stop mode			10	µA
Input capacitance	C_{IN}	Pins other than V_{DD}, V_{SS}, AV_{DD}, AV_{SS}	Clock 1MHz 0V for all pins excluding measured pins		10	20	pF

[*1] RST is specified only in evaluation mode.

[*2] In RST, the input current is specified when pull-up resistor is selected; the leakage current is specified when no resistor is selected.

[*3] When all output pins are open.

[*4] When the upper two bits (CPU clock selected) of the clock control register (CLC: 0002FEh) are set to "00" and the LSI is operated in high-speed mode (1/2 frequency dividing clock).

[*5] When the clock generator output is not selected at PI6.

AC Characteristics

(1) Clock timing
(Ta = −20 to +75°C, Vss = 0V reference)

Item	Symbol	Pin	Conditions		Min.	Max.	Unit
System clock frequency	f_C	XTAL, EXTAL	Fig. 1, Fig. 2	V_{DD} = 5.0V ± 10%	1	20	MHz
				V_{DD} = 3.0V ± 10%	1	20	MHz
System clock input pulse width	t_{XH}, t_{XL}	EXTAL	Fig. 1, Fig. 2 External clock drive	V_{DD} = 5.0V ± 10%	20		ns
				V_{DD} = 3.0V ± 10%	20		ns
System clock input rise time, fall time	t_{CR}, t_{CF}	EXTAL	Fig. 1, Fig. 2 External clock drive	V_{DD} = 5.0V ± 10%		200	ns
				V_{DD} = 3.0V ± 10%		200	ns
Event count input clock pulse width	t_{EH}, t_{EL}	PF0/EC0, PF1/EC2	Fig. 3	V_{DD} = 5.0V ± 10%	t_{sys} + 50[*1]		ns
				V_{DD} = 3.0V ± 10%	t_{sys} + 100[*1]		ns
Event count input clock rise time, fall time	t_{ER}, t_{EF}	PF0/EC0, PF1/EC2	Fig. 3	V_{DD} = 5.0V ± 10%		20	ms
				V_{DD} = 3.0V ± 10%		20	ms

[*1] t_{sys} indicates the three values below according to the upper two bits (CPU clock selected) of the clock control register (CLC: 0002FEh).

t_{sys} [ns] = 2000/fc (upper two bits = "00"), 4000/fc (upper two bits = "01"), 16000/fc (upper two bits = "11")

Fig. 1. Clock timing

Fig. 2. Clock applied conditions
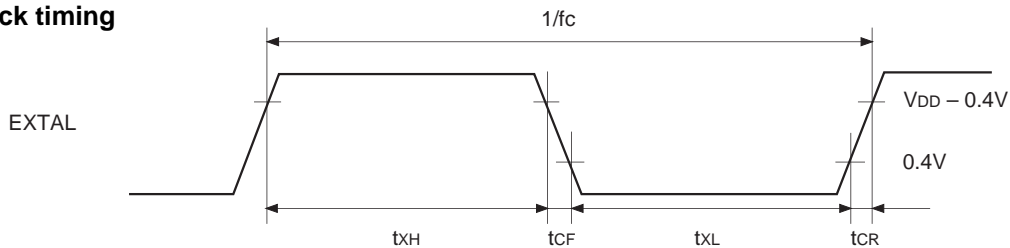

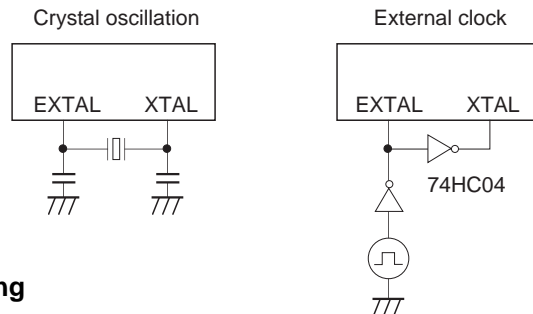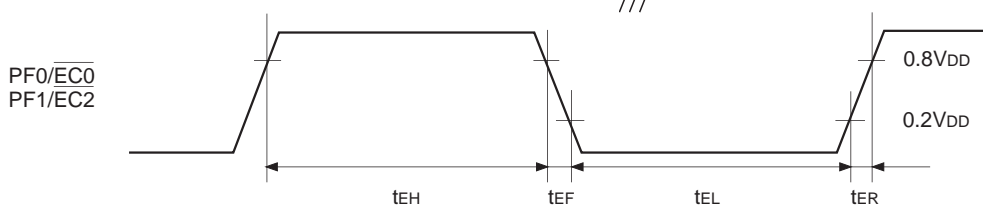### Fig. 3. Event count clock timing

– 16 –

(2) Serial interface (CH0, CH1, CH2)

(Ta = −20 to +75°C, Vss = 0V reference)

Item	Symbol	Pin	Conditions		Min	Max.	Unit
$\overline{CS} \downarrow \rightarrow \overline{SCK}$ delay time	t_{DCSK}	$\overline{SCK0}$, $\overline{SCK1}$, $\overline{SCK2}$	Chip select transfer mode (SCK = output mode)	VDD = 5.0V ± 10%		tsys + 200	ns
				VDD = 3.0V ± 10%		tsys + 250	
$\overline{CS} \uparrow \rightarrow \overline{SCK}$ float delay time	t_{DCSKF}	SO0, SO1, SO2	Chip select transfer mode (SCK = output mode)	VDD = 5.0V ± 10%		tsys + 200	ns
				VDD = 3.0V ± 10%		tsys + 250	
$\overline{CS} \downarrow \rightarrow SO$ delay time	t_{DCSO}	SO0, SO1, SO2	Chip select transfer mode	VDD = 5.0V ± 10%		tsys + 200	ns
				VDD = 3.0V ± 10%		tsys + 250	
$\overline{CS} \uparrow \rightarrow SO$ float delay time	t_{DCSOF}	$\overline{CS0}$, $\overline{CS1}$, $\overline{CS2}$	Chip select transfer mode	VDD = 5.0V ± 10%		tsys + 200	ns
				VDD = 3.0V ± 10%		tsys + 250	
$\overline{CS}$ high level width	t_{WHCS}	$\overline{SCK0}$, $\overline{SCK1}$, $\overline{SCK2}$	Chip select transfer mode	VDD = 5.0V ± 10%	tsys + 100		ns
				VDD = 3.0V ± 10%	tsys + 100		
$\overline{SCK}$ cycle time	t_{KCY}	$\overline{SCK0}$, $\overline{SCK1}$, $\overline{SCK2}$	Input mode	VDD = 5.0V ± 10%	2tsys + 200		ns
				VDD = 3.0V ± 10%	2tsys + 200		
			Output mode	VDD = 5.0V ± 10%	16000/fc		ns
				VDD = 3.0V ± 10%	16000/fc		
$\overline{SCK}$ high, low level width	t_{KH}, t_{KL}	$\overline{SCK0}$, $\overline{SCK1}$, $\overline{SCK2}$	Input mode	VDD = 5.0V ± 10%	tsys + 100		ns
				VDD = 3.0V ± 10%	tsys + 100		
			Output mode	VDD = 5.0V ± 10%	8000/fc − 50		ns
				VDD = 3.0V ± 10%	8000/fc − 75		
SI input setup time (for $\overline{SCK} \uparrow$)	t_{SIK}	SI0, SI1, SI2	$\overline{SCK}$ input mode	VDD = 5.0V ± 10%	100		ns
				VDD = 3.0V ± 10%	100		
			$\overline{SCK}$ output mode	VDD = 5.0V ± 10%	200 − tsys		ns
				VDD = 3.0V ± 10%	200 − tsys		
SI input hold time (for $\overline{SCK} \uparrow$)	t_{KSI}	SI0, SI1, SI2	$\overline{SCK}$ input mode	VDD = 5.0V ± 10%	tsys + 100		ns
				VDD = 3.0V ± 10%	tsys + 100		
			$\overline{SCK}$ output mode	VDD = 5.0V ± 10%	tsys + 100		ns
				VDD = 3.0V ± 10%	tsys + 100		
$\overline{SCK} \downarrow \rightarrow SO$ delay time	t_{KSO}	SO0, SO1, SO2	$\overline{SCK}$ input mode	VDD = 5.0V ± 10%		tsys + 100	ns
				VDD = 3.0V ± 10%		tsys + 150	
			$\overline{SCK}$ output mode	VDD = 5.0V ± 10%		50	ns
				VDD = 3.0V ± 10%		100	
Minimum interval time	t_{INT}	$\overline{SCK0}$, $\overline{SCK1}$, $\overline{SCK2}$	$\overline{SCK}$ input mode	VDD = 5.0V ± 10%	2tsys + 100		ns
				VDD = 3.0V ± 10%	2tsys + 125		
			$\overline{SCK}$ output mode	VDD = 5.0V ± 10%	8000/fc − 50		ns
				VDD = 3.0V ± 10%	8000/fc − 75		

Note 1) t_{SYS} indicates the three values below according to the upper two bits (CPU clock selected) of the clock control register CLC (address: 0002FEh).

t_{SYS} [ns] = 2000/fc (upper two bits = "00"), 4000/fc (upper two bits = "01"), 16000/fc (upper two bits = "11")

Note 2) The load condition for the SCK output mode, SO output delay time is 150pF when V_{DD} = 5.0V ± 10% and 100pF when V_{DD} = 3.0V ± 10%.

Fig. 4. Serial interface CH0, CH1, CH2 timing
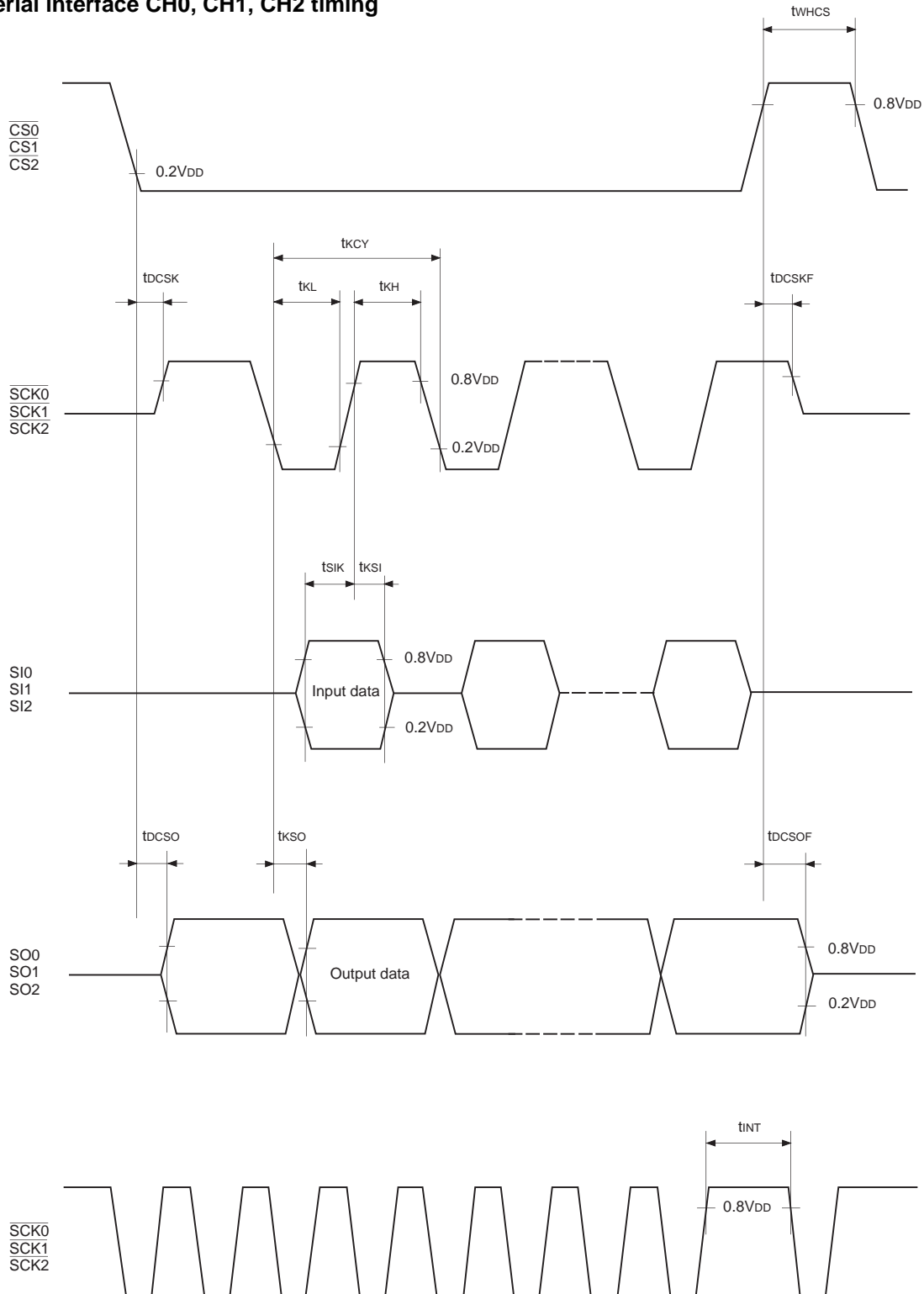
(3) A/D converter characteristics

(Ta = −20 to +75°C, V_{DD} = AV_{DD} = AV_{REF} = 2.7 to 5.5V, V_{SS} = AV_{SS} = 0V reference)

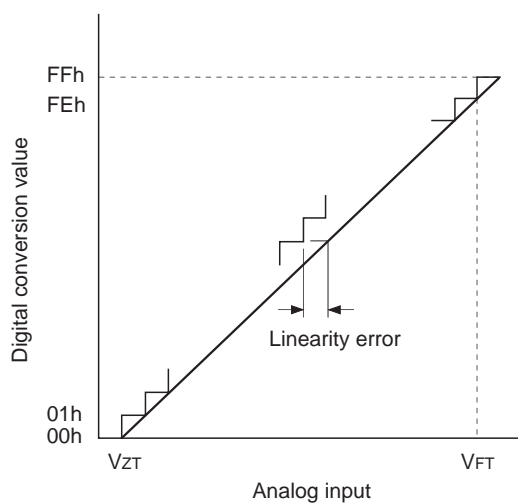| Item	Symbol	Pin	Conditions		Min.	Typ.	Max.	Unit
Resolution							8	Bits
Linearity error				V_{DD} = AV_{DD} = 5.0V			±1.5	LSB
				V_{DD} = AV_{DD} = 3.0V			±1.5	
Zero transition voltage	V_{ZT}*1		Ta = 25°C	V_{DD} = AV_{DD} = 5.0V	−10	10	50	mV
				V_{DD} = AV_{DD} = 3.0V	−10	5	35	
Full-scale transition voltage	V_{FT}*2			V_{DD} = AV_{DD} = 5.0V	4935	4975	5015	mV
				V_{DD} = AV_{DD} = 3.0V	2955	2985	3015	
Conversion time	t_{CONV}				200tsys			µs
Sampling time	t_{SAMP}				14tsys			µs
Reference input voltage	V_{REF}	AV_{REF}			$0.9AV_{DD}$		AV_{DD}	V
Analog input voltage	V_{IAN}	AN0 to AN11			0		AV_{REF}	V
AVREF current	I_{REF}	AV_{REF}	Operation mode	V_{DD} = 5.5V		0.65	1.2	mA
				V_{DD} = 3.6V		0.45	0.8	
	I_{REFS}		Sleep mode Stop mode	V_{DD} = 5.5V			10	µA
				V_{DD} = 3.6V			10	

*1 V_{ZT}: Value at which the digital conversion value changes from 00h to 01h and vice versa.

*2 V_{FT}: Value at which the digital conversion value changes from FEh to FFh and vice versa.

Note) tsys indicates the three values below according to the upper two bits (CPU clock selected) of the clock control register (CLC: 0002FEh).

tsys [ns] = 2000/fc (upper two bits = "00"), 4000/fc (upper two bits = "01"), 16000/fc (upper two bits = "11")

Fig. 5. Definition of A/D converter terms

(4) Interruption and reset input (Ta = −20 to +75°C, V_{DD} = 2.7 to 5.5V, V_{SS} = 0V reference)

Item	Symbol	Pin	Conditions	Min.	Max.	Unit
External interruption high, low level width	t_{IH}, t_{IL}	$\overline{NMI}$ $\overline{INT0}$ $\overline{INT1}$ $\overline{INT2}$ PD0 to PD7		1		μs
Reset input low level width	t_{RSL}	$\overline{RST}$		6t_{sys}[1]		μs

[1] t_{sys} indicates the three values below according to the upper two bits (CPU clock selected) of the clock control register (CLC: 0002FEh).

t_{sys} [ns] = 2000/fc (upper two bits = "00"), 4000/fc (upper two bits = "01"), 16000/fc (upper two bits = "11")

Fig. 6. Interruption input timing

$\overline{NMI}$
$\overline{INT0}$
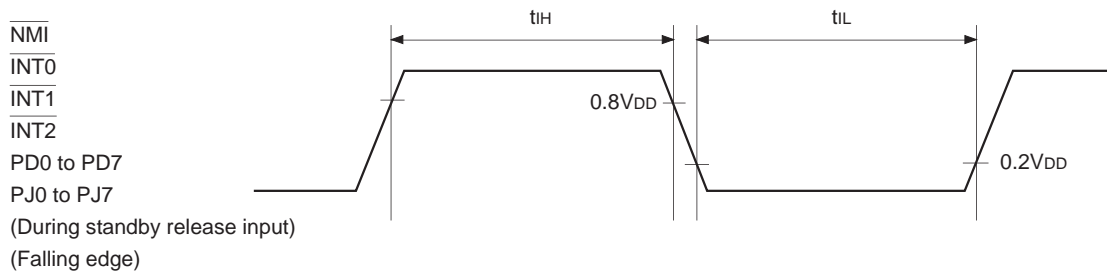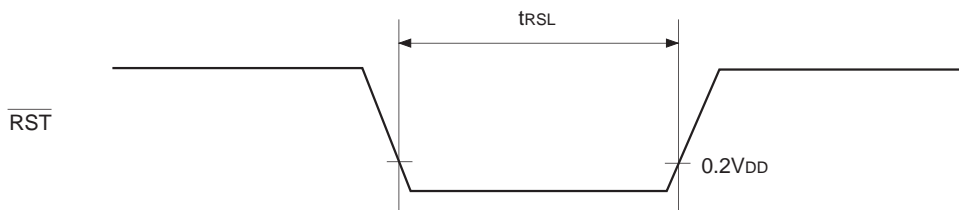$\overline{INT1}$
$\overline{INT2}$
PD0 to PD7
PJ0 to PJ7
(During standby release input)
(Falling edge)

t_{IH} t_{IL}

0.8V_{DD} 0.2V_{DD}

Fig. 7. $\overline{RST}$ input timing

$\overline{RST}$

t_{RSL}

0.2V_{DD}

(5) General-purpose prescaler

(Ta = −20 to +75°C, Vss = 0V reference)

Item	Symbol	Pin	Conditions		Min.	Typ.	Max.	Unit
External clock input frequency	f_{PCK}	PCK		$V_{DD} = 5.0V \pm 10\%$			12	MHz
				$V_{DD} = 3.0V \pm 10\%$			12	
External clock input pulse width	t_{WH}, t_{WL}	PCK		$V_{DD} = 5.0V \pm 10\%$	33			ns
				$V_{DD} = 3.0V \pm 10\%$	33			
External clock input rise time, fall time	t_R, t_F	PCK		$V_{DD} = 5.0V \pm 10\%$			200	ns
				$V_{DD} = 3.0V \pm 10\%$			200	
Prescaler output delay time (for PCK ↑)	t_{PLH}	PO	External clock input PCK $t_R = t_F = 6ns$	$V_{DD} = 5.0V \pm 10\%$		80	130	ns
				$V_{DD} = 3.0V \pm 10\%$		130	220	
	t_{PHL}			$V_{DD} = 5.0V \pm 10\%$		60	100	ns
				$V_{DD} = 3.0V \pm 10\%$		90	150	
Prescaler output rise time, fall time	t_{TLH}	PO	External clock input PCK $t_R = t_F = 6ns$	$V_{DD} = 5.0V \pm 10\%$		50	100	ns
				$V_{DD} = 3.0V \pm 10\%$		100	280	
	t_{THL}			$V_{DD} = 5.0V \pm 10\%$		20	40	ns
				$V_{DD} = 3.0V \pm 10\%$		40	80	

Note) PO pin load condition: 50pF

Fig. 8. General-purpose prescaler timing
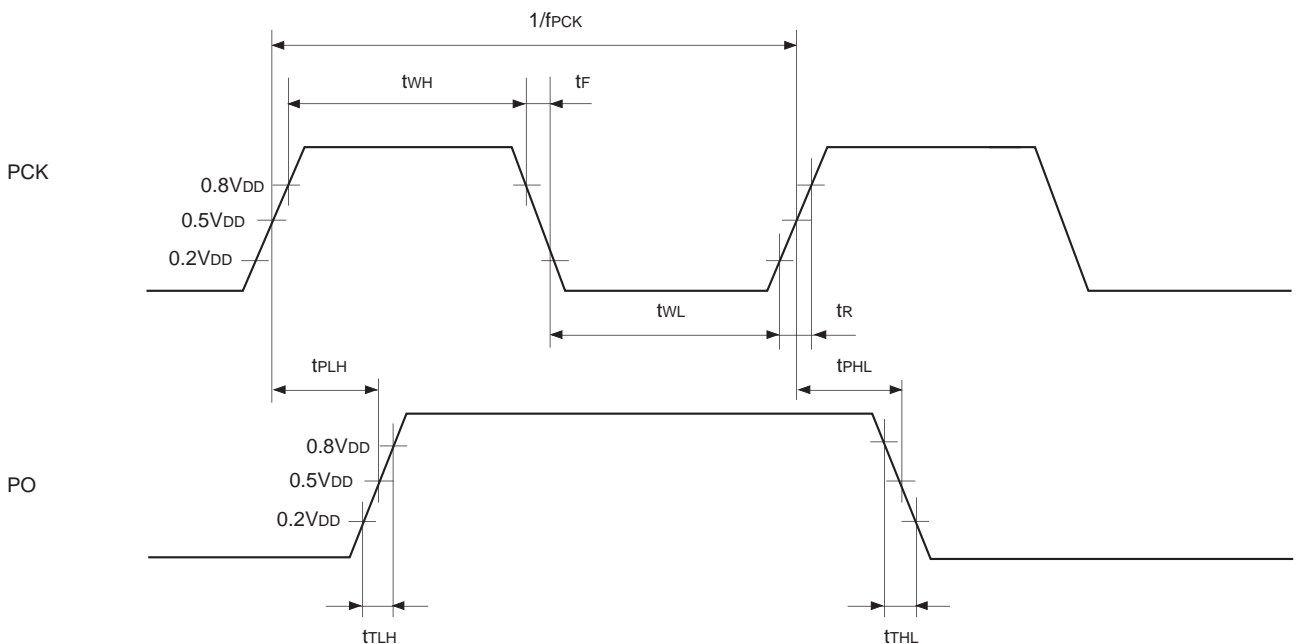
(6) Other

(Ta = −20 to +75°C, Vss = 0V reference)

Item	Symbol	Pin	Conditions		Min.	Typ.	Max.	Unit
CFG input high, low level width	t$_{CFH}$, t$_{CFL}$	CFG		V$_{DD}$ = 5.0V ± 10%	tsys +200			ns
				V$_{DD}$ = 3.0V ± 10%	tsys +200			
DFG input high, low level width	t$_{DFH}$, t$_{DFL}$	DFG		V$_{DD}$ = 5.0V ± 10%	1000/fc +200			ns
				V$_{DD}$ = 3.0V ± 10%	1000/fc +200			
DPG minimum pulse width	t$_{DPW}$	DPG		V$_{DD}$ = 5.0V ± 10%	50			ns
				V$_{DD}$ = 3.0V ± 10%	50			
DPG minimum removal time	t$_{DPR}$	DPG		V$_{DD}$ = 5.0V ± 10%	50			ns
				V$_{DD}$ = 3.0V ± 10%	50			
RFG input high, low level width	t$_{RFH}$, t$_{RFL}$	RFG0 RFG1		V$_{DD}$ = 5.0V ± 10%	tsys +200			ns
				V$_{DD}$ = 3.0V ± 10%	tsys +200			
EXI input high, low level width	t$_{EIH}$, t$_{EIL}$	EXI0 EXI1	When tsys = 2000/fc	V$_{DD}$ = 5.0V ± 10%	tsys +200			ns
				V$_{DD}$ = 3.0V ± 10%	tsys +200			
PMI input high, low level width	t$_{PIH}$, t$_{PIL}$	PMI		V$_{DD}$ = 5.0V ± 10%	tsys +200			ns
				V$_{DD}$ = 3.0V ± 10%	tsys +200			
PMSK minimum pulse width	t$_{PMW}$	PMSK		V$_{DD}$ = 5.0V ± 10%	tsys +200			ns
				V$_{DD}$ = 3.0V ± 10%	tsys +200			
PMSK minimum removal time	t$_{PMR}$	PMSK		V$_{DD}$ = 5.0V ± 10%	tsys +200			ns
				V$_{DD}$ = 3.0V ± 10%	tsys +200			
XOUT output rise time, fall time	t$_{TLH}$	XOUT	When the load is 50pF	V$_{DD}$ = 5.0V ± 10%		50	100	ns
				V$_{DD}$ = 3.0V ± 10%		100	280	
	t$_{THL}$			V$_{DD}$ = 5.0V ± 10%		20	40	
				V$_{DD}$ = 3.0V ± 10%		40	80	

Note) tsys indicates the three values below according to the upper two bits (CPU clock selected) of the clock control register (CLC: 0002FEh).
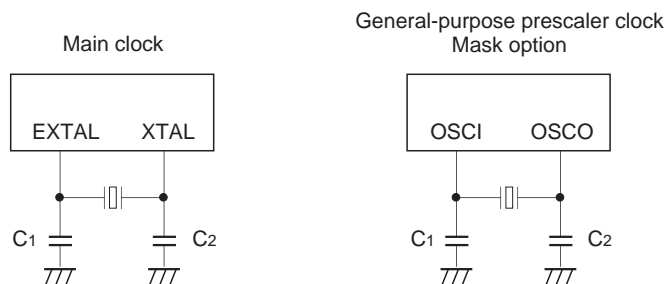
tsys [ns] = 2000/fc (upper two bits = "00"), 4000/fc (upper two bits = "01"), 16000/fc (upper two bits = "11")

Fig. 9. Other timing
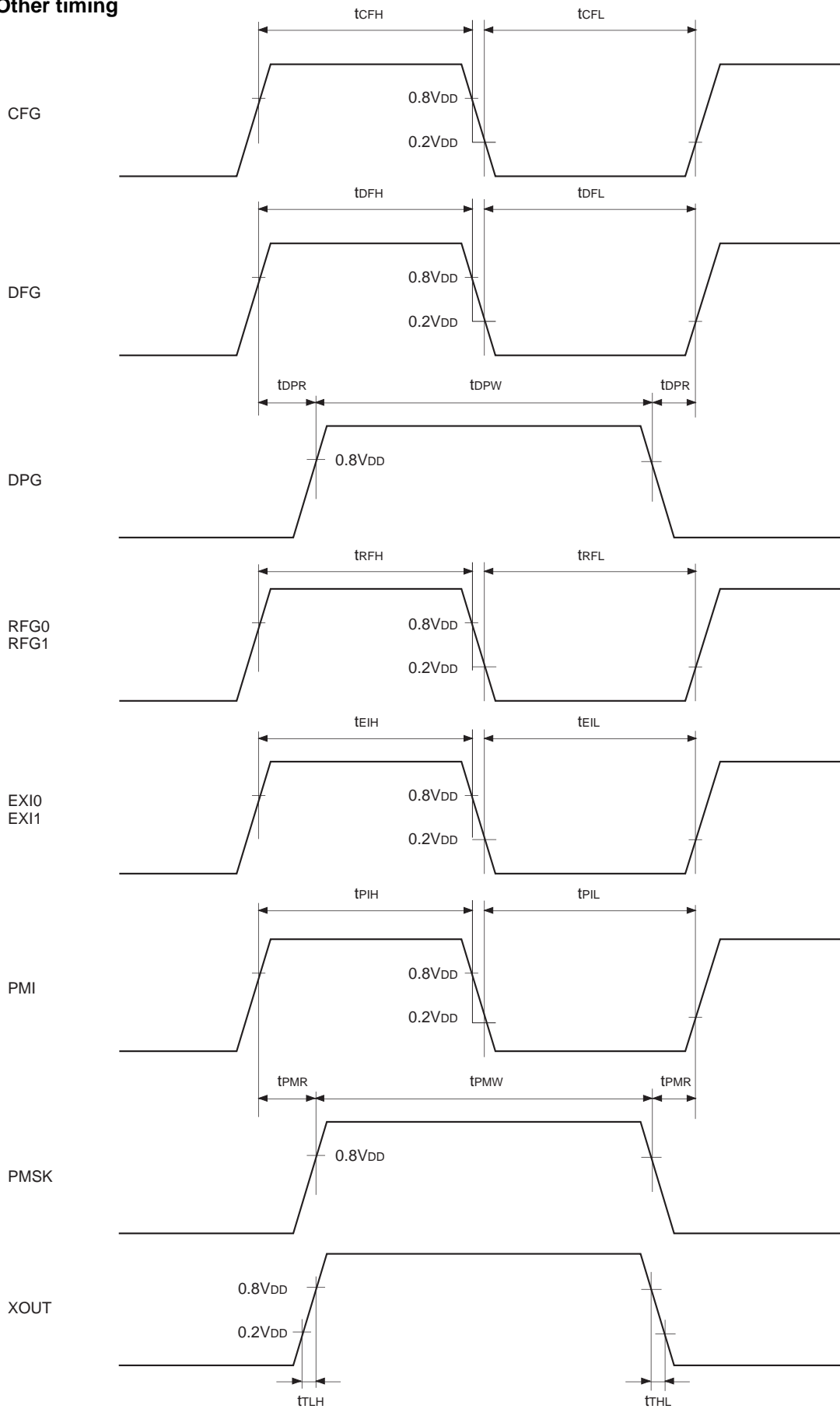
Appendix

Fig. 10. Recommended oscillation circuit

Main clock

General-purpose prescaler clock
Mask option

Manufacturer	Model	fc (MHz)	Main clock		General-purpose prescaler clock	
			C_1 (pF)	C_2 (pF)	C_1 (pF)	C_2 (pF)
RIVER ELETEC CORPORATION	HC-49/U03	12	10	10	4	4
		16				
		20				
KINSEKI LTD.	HC-49/U (-S)	12	10	10	4	4
		16				
		20				

Note 1) Use the general-purpose prescaler clock at 12MHz or less.
Note 2) Crystals and capacitors should be placed near the LSI and wiring should be as short as possible.
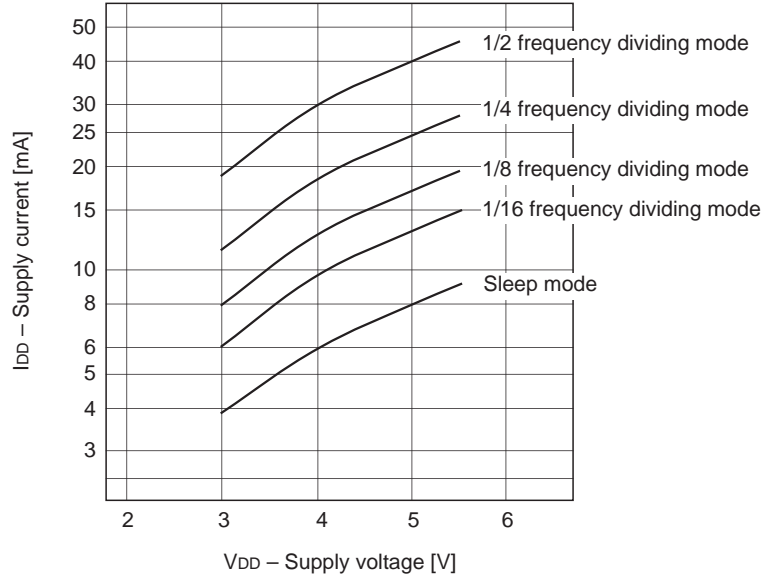
Mask option table

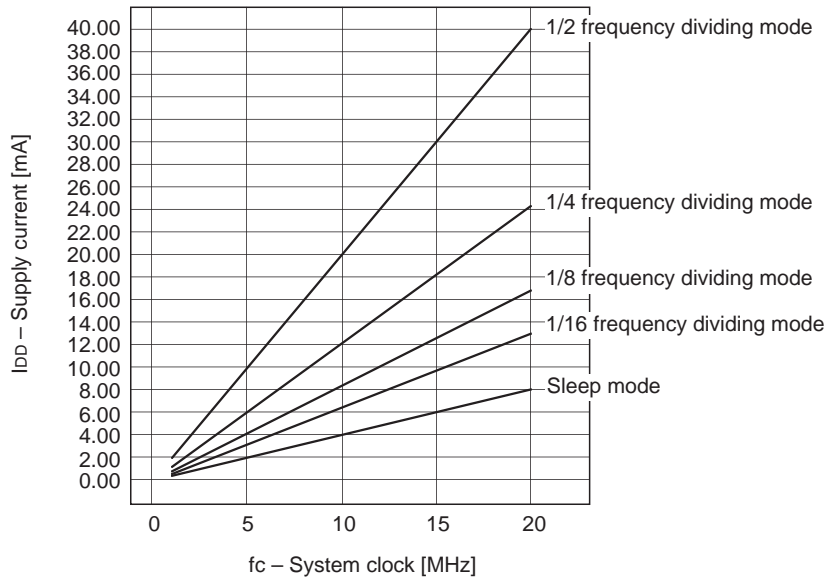| Item	Selection	
EXTAL system operating voltage[1]	2.7 to 5.5V	4.5 to 5.5V
Reset pin pull-up resistor	Non-existent	Existent
PH2 input format	CMOS Schmitt trigger	TTL Schmitt trigger
PH3 input format	CMOS Schmitt trigger	TTL Schmitt trigger
PI4/PI5 pin format	Oscillation circuit	Input pin

[1] Select 4.5V to 5.5V when this LSI is used with a supply voltage range of 4.5V to 5.5V.

Example of Representative Characteristics

IDD vs. VDD
(fc = 20MHz, Ta = 25°C, Typical)

IDD – Supply current [mA] vs. VDD – Supply voltage [V]

1/2 frequency dividing mode
1/4 frequency dividing mode
1/8 frequency dividing mode
1/16 frequency dividing mode
Sleep mode

IDD vs. fc
(VDD = 5V, Ta = 25°C, Typical)

IDD – Supply current [mA] vs. fc – System clock [MHz]

1/2 frequency dividing mode
1/4 frequency dividing mode
1/8 frequency dividing mode
1/16 frequency dividing mode
Sleep mode

Package Outline   Unit: mm

100PIN LQFP (PLASTIC)

□ 16.0 ± 0.2

∗ □ 14.0 ± 0.1

75   51

76   50

100   26 (0.22)

1   25

0.5

0.18 +0.08 −0.03

⊕ 0.13 Ⓜ

A

(15.0)

0.5 ± 0.2

1.5 +0.2 −0.1

0.127 +0.05 −0.02

⌒ 0.1

0.1 ± 0.1

0° to 10°

0.5 ± 0.2
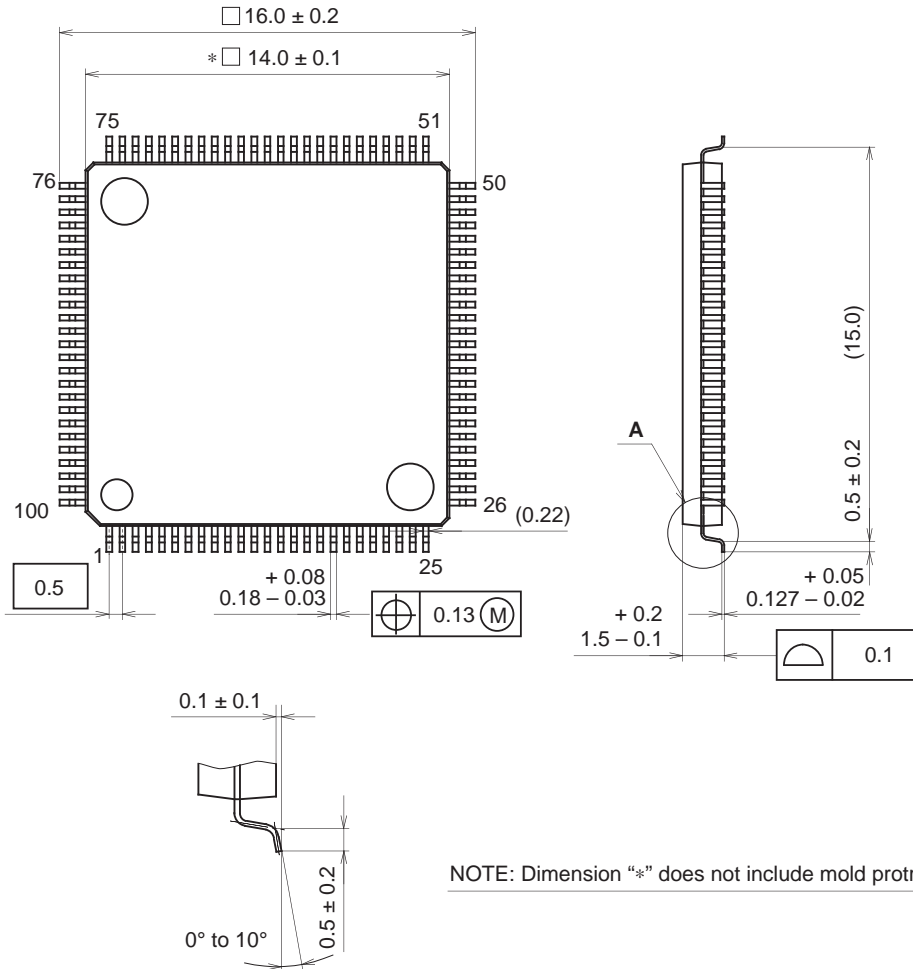
NOTE: Dimension "∗" does not include mold protrusion.

DETAIL **A**

SONY CODE	LQFP-100P-L01
EIAJ CODE	LQFP100-P-1414
JEDEC CODE	—

PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42 ALLOY
PACKAGE MASS	0.8g